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Australia

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- (56) Prior Art Documents US 4668752
- (57) Claim

1. ^A multilayer heat-sealable thermoplastic film structure having improved heat seal performance after electron beam irradiation, said film structure comprising at least one heat-sealable outer layer (A) and at least one core layer (B), wherein layer (A) comprises ^a first linear polyethylene characterized as having:

(a) a density from 0.88 g/cm³ to 0.92 g/cm³.

(b) a melt index, measured as 12 , from 2 g/10 minutes to 20 g/10 minutes,

(c) a molecular weight distribution, measured as I₁₀/I₂, from 5 to 8, and wherein

(d) ¹⁵ percent by weight or less of said first linear polyethylene has a degree of branching less than or equal to ² methyls/1000 carbons, and

(e) ²⁵ percent by weight or less of said first linear polyethylene has a degree of branching equal to or greater than ²⁵ methyls/1000 carbons, and wherein layer (B) comprises a second linear polyethylene characterized as having:

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(f) a density from 0.88 g/cm³ to 0.94 g/cm³, (g) a melt index, measured as I2, from 0.05 g/10 minutes to ⁵ g/10 minutes, and

(h) a molecular weight distribution, measured $\ddot{}$ as I_10/I_2 , from 8 to 30.

3. The film structure defined by claim ¹ or 2 which has been electron beam irradiated from 0.5 Mrad to 20 Mrad to form an irradiated film structure.

8. The irradiated film structure according to any one of claims ¹ to 7 which has been subsequently heat sealed to form an irradiated and heat sealed film structure.

(57) Abstract

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Multilayer thermoplastic film structures comprising at least one heat-sealable outer layer (A) and at least one core layer (B) are disclosed. Layer (A) has improved heat sealability after irradiation (e.g. electron beam). Layer (B) has improved shrinkage after irradiation. Layer (A) is ^a linear polyethylene having ^a melt index from ² to ²⁰ g/¹⁰ minutes, ^a density from 0.88 to 0.92 g/ cm³, a molecular weight distribution (I_{10}/I_2) from 5 to 8, a fraction of the polyethylene having a degree of branching less than or equal to 2 methyls/1000 carbons of not more than 15 percent by weight and a fraction of the polyethylene having a than or equal to 2 methyls/1000 carbons of not more than 15 percent by weight and a fraction of the degree of branching greater than or equal to 25 methyls/1000 carbons of not more than 25 percent by weight of the polymer. Layer (B) is a linear polyethylene having a melt index from 0.05 to 5 g/10 minutes, a density from 0.88 to 0.94 g/cm³ and a molecular weight distribution (I_{10}/I_2) from 8 to 30.

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Heat sealable multilayer polyolefinic film structures.

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This invention relates to oriented multilayer, heat sealable thermoplastic film structures. More particularly, the invention relates to multilayer film structures which retain heat sealability even after irradiation.

Many polymers have been developed which can withstand exposure to irradiation, often incorporating 10 specific additives or antioxidants which prevent polymer degradation. Films and multilayer films made from these and other polymers are sometimes exposed to irradiation during processing or use. For example, irradiation is used in some instances to destroy micro-organisms in the ¹⁵ wrapped product (e.g., in food sterilization) and to also prepare at least one component of the film for thermal shrinkage at ^a later time.

Multilayer film packaging has many requirements ²⁰ for both enduring the irradiation exposure and preparing part of the structure for subsequent shrinkage. Typically, the package is a multilayer structure, with the different layers performing different functions. 25 Usually the layers are made from thermoplastic polymers.

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For example, one layer may be a barrier layer (e.g., ethylene vinyl alcohol (EVOH)), the heat seal layer may be a polyethylene (e.g., linear low density polyethylene (LLDPE)), while still another type of polyethylene (e.g., high density polyethylene (HDPE)) might be used · as the structural or core layer.

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Irradiation of multilayer film structures can be done by exposure to Cobalt ⁶⁰ (gamma irradiation) or 10 by electron beam (beta). When the entire multilayer film structure is irradiated, the heat sealability of the heat seal layer often decreases (i.e.,, the intiation temperature of the heat sealing increases), especially when the heat seal layer is polyethylene, while the

- ¹⁵ physical properties (e.g., strength) of the structural layer increase. Reduction in heat sealability causes lower heat seal strengths and narrower heat sealing temperature ranges. Exposure to irradiation, especially beta irradiation, and subsequent exposure to heat can ²⁰ also cause the core layer and the heat seal layer to [|] shrink, especially when the multilayer structure has been oriented (e.g., film). Controlled shrinkage of the
- core layer is desirable, but a narrower heat sealing 25 temperature range of the heat seal layer is not desirable. **In the contract of the contract of**

Irradiation of the heat seal layer also results in higher heat seal initiation temperatures as well as 30 narrower heat seal temperature ranges. The narrow heat seal range of the heat seal layer can cause the wrapped product to become exposed to the external environment and contamination, thus negating the sterilizing effects of irradiation.

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USP 4,927,708 (Herran et al.) discloses an improvement in multilayer thermoplastic film having at least ⁵ layers wherein a core layer comprises a very low density polyethylene, intermediate layers adjacent each side of the core layer comprising ^a linear low density 5 polyethylene and two outer layers each bonded to the respective intermediate layer comprising a very low density polyethylene. The very low density polyethylene can have a density between 0.890 and 0.915 grams/cubic centimeter $(g/cm³)$. There is no disclosure as to the 10 molecular weight distribution, nor is there any reference to the short chain branching distribution of any of the layers.

¹⁵ USP 4,798,081 (Hazlitt et al.) discloses ^a method and apparatus for analyzing a solution of a crystalline or semi-crystalline polymer sample (e.g., polyethylene). The analysis includes temperature rising elution fractionation (TREF) which measures the degree ²⁰ of branching of select fractions of the polymer sample.

USP 4,755,419 (Shah) discloses a 7-layer coextruded oriented film comprising a core layer of 25 ethylene-vinyl alcohol copolymer, two intermediate layers each comprising a polyamide, two outer layers each comprising a blend of polymeric materials and two layers each comprising an adhesive polymeric material. The blend of polymeric materials are taken from the ³⁰ group consisting of (i) a blend of linear low density polyethylene, a linear medium density polyethylene and an ethylene vinyl acetate copolymer and (ii) ^a blend of an ethylene propylene copolymer and a polypropylene.

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USP 4,724,185 (Shah) discloses a coextruded multiple layer oriented film. The core layer comprises a cross-linked blend of ethylene vinyl alcohol copolymer and polyamide. Two cross-linked interior layers each comprising adhesive resins and two cross-linked outer layers each comprising a ³ component blend of linear low density polyethylene, linear medium density polyethylene and ethylene-vinyl acetate, are each included in the multiple layer film.

USP 4,668,752 (Tominari et al.) discloses ethylene/C4-C20 alpha-olefin copolymers which have new characteristics in regards to composition distribution, degree of branching, randomness and crystallinity. The ¹⁵ ethylene copolymers have various properties, including a melt flow rate of from 0.01 to 200 g/10 minutes, a molecular weight distribution measured as Mw/Mn of $2.5 \leq Mw/Mn \leq 10$, a density of from 0.850 to 0.930 $g/cm³$, the amount of components having a degree of ²⁰ branching of not more than 2/1000 carbons of not more than ¹⁰ percent by weight based on the ethylene copolymer and the amount of components having a degree of branching of at least 30/1000 carbons of not more

25 than 70 percent by weight based on the ethylene copolymer. The disclosure alleges that the ethylene copolymers made using this invention have excellent mechanical properties, optical properties, blocking resistance, heat resistance and low temperature heat

³⁰ sealability in a well balanced combination. Tominari et al. do not specify how the ethylene/C4-C20 alpha-olefin copolymers perform when exposed to irradiation, much less how they perform when in a multilayer structure that is exposed to irradiation.

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USP 4,640,856 (Ferguson et al.) discloses multi-layer thermoplastic shrink film having improved shrink, toughness and barrier properties achieved by ^a substrate layer of very low density polyethylene and a gas barrier layer of vinylidene chloride copolymer or ethylene-vinyl alcohol. The very low density polyethylene can have a density of less than 0.910 g/cm³ and as low as 0.860 g/cm³ or even lower. there is no disclosure as to the molecular weight distribution, nor 10 is there any reference to the short chain branching distribution of the substrate layer.

USP 4,352,849 (Mueller) discloses multilayer heat shrinkable packaging film comprising a core layer ¹⁵ consisting essentially of an ethylene-propylene copolymer blended with an ethylene-vinyl acetate copolymer and a skin or surface layer comprising an ethylene-propylene copolymer.

on USP 4,064,296 (Bornstein et al.) discloses ^a multi-layer packaging film having low oxygen permeability comprising two polymeric layers, at least one of which is cross-linked, and a layer between the polymeric layers comprising a hydrolyzed ethylene vinyl 25 acetate copolymer. The two polymeric layers can comprise polyethylene, although the type of polyethylene is not specified.

³⁰ USP 4,820,557 (Warren) discloses a packaging film comprising at least one layer of a linear copolymer of ethylene and an alpha-olefin with a density of about 0.935 g/cm³ or less and a low I_{10}/I_2 ratio. The film allegedly has better abuse resistance as compared with a film made with a linear ethylene/alpha-olefin copolymer

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having a comparatively higher I_{10}/I_2 value. Warren is directed to use of polyethylene which has a narrow molecular' weight distribution in order to improve abuse resistance of multilayer structures. Warren specifically teaches away from the use of polyethylene having ^a broad molecular weight distribution (i.e., higher I_{10}/I_2 values) in multilayer film structures.

In spite of these advances, a better balance of ₁₀ heat seal and shrinkage properties of the overall structure is still needed before and after irradiation so that the overall integrity of the package is not lost after irradiation.

¹⁵ ^A multilayer heat-sealable thermoplastic film structure has now been discovered that has improved heat seal performance after irradiation. The novel multilayer film structure comprises at least one heat sealable outer layer (A) and at least one core layer 20 (B) .

Layer (A) of the multilayer thermoplastic film structure comprises ^a first linear polyethylene characterized as having:

25 (a) a density from 0.88 grams/cubic centimeter $(g/cm³)$ to 0.92 $g/cm³$,

 (b) a melt index, measured as I_2 , from 2 grams/10 minutes to 20 grams/10 minutes,

(c) a molecular weight distribution, measured ³⁰ as I10/I2, from ⁵ to 8, and wherein

(d) ¹⁵ percent by weight or less of said linear polyethylene has a degree of branching less than or equal to ² methyls/1000 carbons, and

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(e) 25 percent by weight or less of said linear polyethylene has a degree of branching equal to or greater than 25 methyls/1000 carbons.

Layer (B) comprises a second linear polyethylene characterized as having:

(a) a density from 0.88 g/cm³, to 0.94 g/cm³,

(b) a melt index, measured as 12, from 0.05 grams/10 minutes to ⁵ gram/10 minutes,

(c) a molecular weight distribution, measured as I_{10}/I_{2} , from 8 to 30. $10[°]$

Figure ¹ shows the preparative scale temperature rising elution fractionation apparatus used to determine the branching distribution in the polymer [|] ¹⁵ fractions.

Figure ² plots heat seal strength (measured in Newtons/inch) versus heat seal temperature (in °F) of three ultra low density polyethylene (ULDPE) resins made ; into film.

Figure ³ plots cross-link density (measured in percent gel) versus radiation dosage (in megarads) of two ULDPE resins made into film.

Figure ⁴ plots heat seal strength (measured in 25 Newtons/inch) versus heat seal temperature (in °F) of one ULDPE resin made into film after different levels of exposure to irradiation.

Figure 5 plots heat seal strength (measured in Newtons/inch) versus heat seal temperature (in \degree F) of 30 one ULDPE resin made into film after different levels of exposure to irradiation.

. Figure ⁶ plots cross-link density (measured in percent gel) versus radiation dosage (in megarads) of one LLDPE resin made into film.

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Figure 7 depict one multilayer film structure of the present invention.

The multilayer structures of the present invention comprise at least one heat-sealable outer layer and at least one core layer. The multilayer structure can have many layers, but the heat-sealable layer of the present invention must be on at least one outer surface of the structure to take advantage of the 10 improvement in heat seal characteristics. Typical multilayer structures can be made using a coextruded blown or cast film process. Figure ⁷ shows a multilayer structure of the present invention. The structures of the film product can generally be described as an

¹⁵ A/B/D/X multilayer structure wherein layer ^A (18) is the heat sealable outer layer, layer ^B (19) is the core layer and layers ^D (20) and/or ^X (21) are ^a tie layer(s) and/or a barrier layer(s). The core layer (19) can be adjacent to the heat seal layer, but does not have to ²⁰ be. The multilayer film structure is comprised of from ² to ²⁰ layers, preferably from ² to ⁷ layers.

The multilayer film structure can be irradiated at any point during the process. For example, the heat-25 sealable outer layer and the core layer of the present invention can be coextruded, irradiated and subsequently laminated and oriented (i.e., stretched) 'to make the final multilayer film structure, so long as the heat-³⁰ sealable outer layer is on at least one outer surface of the structure. Conversely, the entire multilayer structure can be formed and oriented, and then subsequently irradiated. The order of the steps of orientation and irradiation is not critical. Irradiation is preferably accomplished by using an

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electron beam (beta) irradiation device at a dosage level of from 0.5 megarad (Mrad) to 20 Mrad.

Thickness of the multilayer film structures can vary from 0.1 mil to 50 mils (.0025 mm to 1.3 mm), ⁵ preferably from 0.5 mils to ¹⁰ mils. (.013 mm to .25 mm). The tie layer(s) and/or the barrier layer(s) are made from conventional thermoplastic polymers known to be useful for this purpose, especially polyolefinic 10 polymers.

Thermoplastic polymers useful as the tie layer(s) include ethylene acrylic acid interpolymers (e.g., U.S. Patent 4,599,392), ethylene methacrylic acid ¹⁵ interpolymers (e.g., U.S. Patent 4,248,990 and U.S. Patent 4,252,924), succinic acid or succinic anhydride grafted polyolefins and blends with ungrafted polyolefins (e.g,, U.S. Patents 4,684,576, 4,741,970 and 4,394,485), vinyl acetate interpolymers. Thermoplastic ²⁰ polymers useful for the barrier layer(s) include EVOH, polyvinyl chloride, polyvinylidene chloride, and nylon.

The heat-sealable outer layer and the core 25 layer of the present invention are fabricated from linear polyethylene. Manufacture of linear polyethylene is disclosed, e,g., in U.S. Patent 4,076,698 and involves coordination catalysts of the "Ziegler" type or "Phillips" type and includes variations of the Ziegler ³⁰ type, such as the Natta type. These catalysts may be used at very high pressures, but may also (and generally are) used at very low or intermediate pressures. The products made by these coordination catalysts are generally known as "linear" polymers because of the substantial absence of branched chains of polymerized

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monomer units pendant from the main polymer "backbone." It is these linear polymers to which the present invention pertains. Linear low density polyethylene (LLDPE) and ultra low density polyethylene (ULDPE) typically have a density between about 0.88 g/cm³ and about 0.94 g/cm³. The density of the polyethylene is lowered by copolymerizing ethylene with minor amounts of an alpha, beta-ethylenically unsaturated alkene(s) having from ³ to ²⁰ carbons per alkene molecule (e.g., 10 1-propene, 1-butene, 1-pentene, 4-methyl-1-pentene, 1hexene, 1-octene, ¹,9-decadiene and 1,7-octadiene), preferably ⁴ to ⁸ carbon atoms (e.g., 1-butene, 1-hexene and 1-octene) and most preferably ⁸ carbons per alkene molecule (i.e., 1-octene). The amount of the alkene ¹⁵ comonomer is generally sufficient to cause the density of the linear low density polymer to be substantially in the same density range as LDPE, due to the alkyl side chains on the polymer molecule, yet the polymer remains

in the "linear" classification; they are conveniently ²⁰ referred to as "linear low density polyethylene." These polymers retain much of the strength, crystallinity, and toughness normally found in HDPE homopolymers of ethylene, but the higher alkene comonomers impart high 25 "cling" and "block" characteristics to extrusion or cast films and the high "slip" characteristic inherently found in HDPE is diminished.

The use of coordination-type catalysts for 30 copolymerizing ethylene with higher alkenes to make LLDPE and ULDPE copolymers having densities between about 0.88 g/cm³ and about 0.94 g/cm³ is disclosed variously in, e.g., U.S. 2,699,457; U.S. 2,846,425; U.S. 2,862,917; U.S. 2,905,645; U.S. 3,058,963; U.S. 4,076,698; and U.S. 4,668,752. The density of the

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linear polyethylene useful in the heat sealable outer layer (A) in the present invention is from 0.88 $g/cm³$ to 0.92 $g/cm³$, preferably from 0.89 $g/cm³$ to 0.915 $g/cm³$. The density of the linear polyethylene useful in the core layer (B) in the present invention is from 0.88 $g/cm³$ to 0.94 $g/cm³$, preferably from 0.9 $g/cm³$ to 0.93 g/cm^3 .

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10 15 20 The molecular weight of the LLDPE useful in the present invention is indicated and measured by melt index according to ASTM D-1238, Condition (E) (i.e., 19O°C/2.16 kilograms); also known as 12· The 12 of the linear polyethylene used in the heat sealable outer layer (A) can be as low as 0.5 grams/10 minutes, but is preferably from 2 grams/10 minutes (g/10 minutes) to 20 g/10 minutes, more preferably from ³ g/10 minutes to ¹⁰ g/10 minutes. The I2 of the linear polyethylene used in the core layer (B) can be from 0.05 g/10 minutes to ⁵ $g/10$ minutes, preferably from 0.2 $g/10$ minutes to 1 $g/10$ minutes.

25 30 The molecular weight distribution is indicated and measured by I10/I2 according to ASTM D-1238, Conditions (N) (190°C/10 kilograms) and (E), respectively. The I10/I2 of the heat sealable outer layer (A) can be from ⁵ to 8, preferably from 6.5 to 8. The I₁₀/I₂ of the core layer (B) can be from 8 to 30, preferably from ⁸ to 15. Molecular weight distribution can be achieved by varying catalytic conditions, reactor conditions or feed percentages. Blends of polyethylenes can also be used. Such blends can be prepared by blending separate and discrete polyethylene polymers, or polymerizing the polyethylene polymer in-situ in multiple reactors, (e.g. the technique disclosed in U.S. Patent 3,914,342). It is important that the linear

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polyethylene(s) be well mixed when using discrete polymer blends.

Additives, (e.g., anti-oxidants, pigments, hydrophobic and/or hydrophilic agents. etc_c), may be incorporated into the linear polyethylene to the extent that they do not interfere with the heat sealability of the outer layer and the shrinkability of the core layer after orientation and exposure to irradiation.

10 15 Short chain branching distribution (SCBD) of the polymer fractions of the polyethylene polymers useful in the heat seal layer and the core layer is measured according to the temperature rising elution fractionation (abbreviated herein as "TREF") technique described herein and in U.S. Patent 4,798,081.

Experimental Procedure for Determining Short Chain Branching Distribution:

20 I. TREF Device Design

25 capable of fractionating up to ²⁰ grams of sample. The ^A diagram of the TREF apparatus is shown in Figure 1. The column (1) is ⁴ inches (10 cm) in diameter and 29 inches (74 cm) in length, a size easily column is packed with stainless steel shot (2) and heated by a circulating oil bath (3) . The entire apparatus is enclosed within a hood (not shown) to contain any solvent or heating oil vapors.

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A. Column Construction

The column is constructed of 4 inch (10 cm) schedule ⁴⁰ steel pipe. Legs of one inch (2.5 cm) angle iron were welded on the pipe to keep it in ^a vertical

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position. The end caps are welded on the pipe to prevent any solvent leakage into the oil system. ^A one inch (2.5 cm) hole is left in each end to allow for packing of the column and to accomodate a ¹ inch MPT (2.5 cm) ^x 1/4 inch (0.6 cm) tubing connection.

B. Column Packing

The column is tightly packed with 0.028 inch (.07 cm) diameter stainless steel shot. The ¹⁰ interstitial volume of the column is approximately ¹⁷⁰⁰ milliliters. Stainless steel shot effectively prevents channeling and provides good heat transfer through the column.

¹⁵ C. Heating System

The column temperature is regulated by a Haake N3B circulating bath controlled by a Haake PG-20 temperature programmer (4). The oil used is Primol ³⁵⁵ ²⁰ mineral oil or ^a light silicon oil. The ¹⁰ gallon (38 1) insulated bath (5) containing the column is galvanized steel. The oil circulator injects oil at the bottom of this bath with the return from the top. An air driven motor (6) is used for agitation of the large 25 oil bath.

D. Solvent System

The solvent used is 1, 2, 4-trichlorobenzene ³⁰ (TCB) (12). It is pumped from ^a reservoir (7) into the bottom of the column through a preheating coil (8) located in the large bath. The solvent is pumped at ^a flow rate of approximately 40 ml/minute using a Fluid Metering, Inc. lab pump (9) designated RP-G-150 with a 2-SSY (3/8 inch or 0.95 cm) stainless steel pump head

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module. This pump allows control of flow rates from ¹ to ¹⁰⁰ milliliters/minute.

E. Column Loading System

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10 Polymer samples (13) are loaded on the column utilizing ^a gravity flow method. The sample is first dissolved in ¹⁷⁰⁰ ml of TCB in ^a heated ⁵ liter flask (10). The 130°C column is then loaded with the solution, also at 130°C. One hundred milliliters of cleaii solvent is then heated and added to flush all transfer lines. These lines are heated with rheostat controlled heat tape (not shown).

F. Fraction Collection

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The column eluent (14) is collected in one gallon metal cans (11). Acetone is then added to the cans to precipitate the polymer. Fraction work-up will be discussed in ^a later section.

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II. Fractionation Procedure and Column Operation

A. Loading the Column

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The polymer sample (about 20 grams) is dissolved in ¹⁷⁰⁰ ml of TCB in ^a heated ⁵ liter flask. Approximately ³ to ⁴ hours is required to carry out this step. The column, the flask, and all transfer lines must be above 120°C to insure that no polymer is precipitated during the loading step. After the polymer

30 solution is deposited on the column, a wash of fresh solvent is used to eliminate all polymer from the transfer lines. The amount of wash is dependent on the volume of the transfer lines (about ¹⁰⁰ ml for this system). After completing these steps, the entire

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system must be brought back down to room temperature, with the rate of cooling being the most critical step in the fractionation procedure. The rates for this system are between 1°C and 2°C/hr. ^A temperature recorder (15) equipped with a thermocouple (16) in the recirculating oil and a thermocouple (17) in the packed column is used to monitor the temperature changes. During the cooling step the polymer selectively crystallizes allowing for efficient fractionation during the elution step. There is no solvent flow through the column during the cooldown step.

B. Column Elution

15 20 25 Elution of the polymer from the column is started at room temperature with a predetermined temperature rise rate. Solvent flows continuously during this step and fractions are collected over the desired change in temperature (5°C for this work). The temperature rise rate used here is 6°C/hr. The temperature rise can be achieved in two ways, stepwise or continuous. Solvent flow rates (40 ml/min) are chosen to achieve one interstitial column volume over the desired change in temperature. These rates result in a fraction collection every 50 minutes. Approximately ¹⁵ fractions are collected for each sample.

C. Fraction Work-Up

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The fractions are mixed about 1:1 with acetone and allowed to sit for at least one day to precipitate the polymer. The polymer-TCB-acetone mixture is then added to ^a large separatory funnel, and allowed to sit for several minutes until the polymer rises to the top.

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The bulk of the solvent is then drained and more acetone added to wash the polymer. The acetone-polymer mixture is then vacuum filtered, and the resulting polymer sample dried in a vacuum oven at 80-90°C followed by weighing. These samples can then be directly used for gel permeation chromatography, differential scanning calorimetry, and infrared analysis.

D. Branching Content Determination

¹⁰ Branching content (i.e., degree of branching) is calculated from CH3/IOOO ^C (methyls/1000 carbons) determination according to ASTM method D2238-68. ^A Beckman 4260 infrared spectrophotometer is employed, using films of approximately 0. ¹⁵ mm thickness. ^A ¹⁵ correction for chain end methyl groups is necessary for accurately determining weight percent comonomer (e.g., 1-octene) incorporation. The correction is done according to the following equation:

Corrected $CH_3/1000C = Uncorrected CH_3/1000C +Vinyl - 2800$ 1000 Mn

²⁵ Comonomer incorporation can be determined from the following equation:

Wt.% octene = (Molecular Weight of 1-octene) (Corrected CH3/IOOOC) (100) 14000 + 84 (corrected CH3/IOOOC)

E. Molecular Weight Determination

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Number average molecular weight (Mn) is measured by using a Waters Model 150C Gel Permeation Chromatograph. The measurements are made by dissolving polymer samples in hot, filtered, 1, 2, ⁴ trichlorobenzene (TCB). The GPC (Gel Permeation Chromatography) runs are made at 14O°C in TCB. ^A flow rate of 1.0 ml/min is used and the columns used are ³ Polymer Laboratories ¹⁰ micron linear columns. Each column diameter is 7.5 mm and the column length is ³⁰ 10 cm. Column performance is typically around 30,000

- plates/meter as determined using 0.02 grams eicosane in ⁵⁰ milliliters of TCB. Columns are disposed of if the plate count is below 20,000 plates per meter. Column performance is also monitored using the multiplied
- ¹⁵ product of the spreading factor "σ" and the slope of the calibration curve "D". This value is typically around 0.081. Columns with values above 0.09 for the multiplied factor "Do" are not employed. The antioxidant butylated hydroxytoluene is added to the TCB
- ²⁰ at ^a concentration of ²⁵⁰ parts per million. The system is calibrated using narrow molecular weight polystyrene standards. The following formula is used to transform polystyrene molecular weights to polyethylene molecular 25 weights:

Mw of polyethylene ⁼ (0.4316) (Mw of polystyrene)

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The polyethylene samples are prepared at a concentration of 0.25 grams of polyethylene in ⁵⁰ milliliters of TCB. The volume injected is ¹⁰⁰ microliters.

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F. Infrared Determination of Vinyl Content

^A Perkin-Elmer Infrared (IR) Model 760 is used to measure vinyl groups in the polymer chains. The polymer is compression molded into a thin film and ⁵ measured for thickness (target is approximately 0.1-0.3 mm thick). The IR absorbancy spectrum is measured for each film and vinyl group content is calculated according to the following equation:

10 Vinyl Groups/ $=$ IR Absorbance at λ ¹⁰⁰⁰ Carbons in the polymer chain (t) (k)

where: t=thickness $k = 0.970$ and $\lambda = 909$ cm⁻¹.

The vinyl groups/1000 carbons value obtained is inserted into the equation for determining corrected CH3/IOOO carbons for each polymer fraction as described earlier in Section ^D in this disclosure.

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The first linear polyethylene suitable for use as the heat seal layer (A) in the present invention has a degree of branching less than or equal to ² a degree of branching fess than or equal to z
methyls/1000 carbons in 15 percent by weight or less, 25 more preferably ¹⁰ percent by weight or less, of the linear polyethyle and a degree of branching equal to or greater than 2. : ithyls/1000 carbons in ²⁵ percent by weight or less, more preferably ²⁰ percent by weight or less, of the first linear polyethylene.

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Example ¹

This example demonstrates heat seal performance of three ULDPE Resins with different short chain branching distributions (SCBD).

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ATTANE* 4002 ULDPE (labeled as Resin A), an ethylene/octene-1 copolymer made by The Dow Chemical· Company, having I2 ⁼ 3-3 grams/10 minutes, *I]q/12 ⁼* 7.7 and density of about 0.912 g/cm³ and $ATTANE*$ 4001 ULDPE ¹⁰ (labeled as Resin B), also an ethylene/octene-1 copolymer made by The Dow Chemical Company, having $I2 =$ 1.0 gram/10 minute, $I_{10}/I_2 = 8.2$ and density of about 0.912 g/cm³ and another ULDPE resin (labeled as Resin C), also an ethylene/octene-1 copolymer, having $I_2 = 3.3$ 15 grams/10 minutes, $I_{10}/I_2 = 7.7$ and density of about 0.912 g/cm³ were made into single layer cast film and evaluated for heat seal performance. Each film sample was heat sealed and then tested for heat seal strength.

²⁰ Resins ^A and ^B had similar short chain branching distributions but differed in I2 and I10/I2· Resin ^C had a "narrower" short chain branching distribution as compared to Resins ^A and B, as measured ²⁵ using TREF, since about 8.5 percent (total weight basis) of Resin ^C had a degree of branching of less than or equal to ² methyls /1000 carbons and about 18.5 percent (total weight basis) Lf Resin ^C had ^a degree of branching of greater than or equal to 25 methyls /1000 30 carbons. The physical properties of the resins used in all of the experiments described herein (Resins A, B, ^C

and D) are summarized in Table 1.

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NM ⁼ Not Measured

Samples of single layer ¹ mil thick films were fabricated from Resins A, ^B and ^C using a cast film line

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equipped with a MPM extruder with a ² inch (5 cm) screw (L/D=24:l) a 12 inch (30 cm) cast film die and a MPM cast film take-up system with a 18 inch (46 cm) chrome plate chill roll and an air knife to cool the polymer melt. The fabrication conditions of the cast film are ²⁵ listed in Table 2.

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The cast film samples were compared for heat seal performance and heat seal strength using an Instron peel test. Film samples for heat seal testing were conditioned as described in ASTM ^E 171-82 (i.e., 73.4 $+/-$ 3.6 °F (21-25°C), 50+/- 5 percent relative

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h'umidity). The heat seal tests were performed utilizing a heat sealer. ^A variety of equipment exists for this function, such as a Sentinel Heat Sealer, a Theller Precision Heat Sealer and a Packforsk Hot Tack Tester (made by Top Wave). The conditions for sealing were ⁵ typically 0.5 second dwell time, ⁴⁰ psi (275 kPa) bar pressure. Both bars were heated. One inch (2.5 cm) wide by six inch (15 cm) long strips were used for testing. After sealing, the samples were conditioned at 10 the ASTM conditions described above for about 24 hours.

The heat seal tests were made using an Instron tensiometer at a constant crosshead speed of about ² inches/minute (5 cm/minute) in a 90° "T-peel" mode. Three to five heat seal tests were made and tested. The ¹⁵ results were averaged ^ar^d are illustrated in Figure ² and the data are summarized in Table 3·

Resin ^C had a "narrower" SCBD and exhibited an improved heat seal performance (i.e., lower heat seal ²⁰ initiation temperature and higher seal strength at below 210°F) as compared to Resin ^A and Resin B. Resin ^C is thus an example of this invention and can be used as a heat seal layer in a multilayer film structure.

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	Heat Seal Temperature (°F)	Heat Seal Strength (Newtons/inch)		
5		Resin A	Resin B	Resin C
	180 $(82^{\circ}C)$	$\mathbf 0$	0	0
	190 (88°C)	0	Ü	9 (3.5 N/cm)
10	200 (93°C)	8 (3.1 N/cm)	5 ⁵ (2 N/cm)	21 (8.3 N/cm)
	210 (99°C)	31 (12.2 N/cm)	30 (11.8 N/cm)	34 (13.4 N/cm)
15 ₁	220 $(104^{\circ}C)$	32 (12.6 N/cm)	34 (13.4 N/cm)	33 (13 N/cm)
	230 $(110^{\circ}C)$	30 (11.8 N/cm)	32 (12.6 N/cm)	31 (12.2 N/cm)
	240 $(116^{\circ}C)$	30 (11.8 N/cm)	32 (12.6 N/cm)	29 (11.4 N/cm)
20	250 (121°C)	30 (11.8 N/cm)	32 (12.6 N/cm)	29 (11.4 N/cm)

TABLE 3 Heat Seal Strength of Resins A, B, AND ^C

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Example 2

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This example demonstrates heat seal performance of election beam irradiated ULDPE.

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Resin ^B and Resin ^C were evaluated for heat seal performance and cross-link density (measured by percent gel) prior to and after electron beam irradiation. An Energy Science Inc. Model EC ²⁰⁰ electron beam radiation machine was used for the radiation treatment. The crosslink density (percent gel in xylene, measured by ASTM method D-2765) indicates the resins' propensity for heat seal performance. The

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cross-link densities of the resins before and after various doses of radiation treatment are illustrated in Figure ³ and the data are summarized in Table 4. As the data show, resin ^C can be exposed to about ⁵ megarads (Mrad) and still maintain ^a cross-link density of less than about ¹⁰ percent gel and thus is an example of this invention. Resin ^B reached a cross-link density of about ¹⁰ percent gel in less than about ³ Mrad exposure and is not an example of this invention for use in the 10 heat seal layer.

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15 seal layer of a multilayer structure demonstrating good The heat seal performance of Resin ^B and Resin ^C prior to and after the radiation treatment was evaluated by the method described in Example 1. The results are illustrated in Figures ⁴ and ⁵ and the data are summarized in Tables ⁵ and 6. The data illustrate that Resin ^C retained good heat seal performance (i.e., a broad temperature bonding window yielding good heat seal values) even after electron beam radiation treatment of up to about ⁴ Mrad of radiation dosage. As Figure ⁴ shows, after an irradiation exposure of about ⁴ Mrad, Resin ^C achieved a heat seal strength of about ¹⁰ Newtons/inch (4 Newtons/cm) or more at a heat seal temperature as low as about 195°F (91°C). Resin ^C is thus an example of this invention for use in the heat heat seal at low temperatures after irradiation.

20 However, for Resin B, heat seal performance deteriorated significantly. After about ⁴ Mrad irradiation dosage, Resin ^B achieved a heat seal strength of about ¹⁰ Newtons/inch (4 Newtons/cm) only after heat sealing at ^a temperature of about 215°F (102°C) or more.

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Example 3

This example demonstrates radiation crosslinking performance of LLDPE resins to be used for the core layer of the multi-layer film products with improved heat seal, orientation and shrink performance.

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10 (.025 mm) thick film using a blown film process. The 15 An octene-1 LLDPE copolymer, labeled as Resin D, having $I_2 = 0.55$ grams/10 minutes, $I_{10}/I_2 = 12$ and **density of about 0.923 g/cm³ was fabricated into ¹ mil blown film is made using ^a STERLING Blown Film Line. This line has a 3.5 inch (8.9 cm) diameter extruder, L/D of 30:1, an ⁸ inch (20 cm) diameter Western Polymer die with a 70 mil (1.8 mm) die gap, a STERLEX barrier type screw and Internal Bubble Cooling (IBC).**

20 Film samples made from this resin were treated by electron beam radiation using an Energy Science Incorpoated electron beam radiation machine (Model EC200; 200 KeV). The treated polymer film was evaluated for propensity for thermal shrinkage by measuring percent gel (i.e., crosslink density) by the solvent extraction technique as described in Example 2.

30 The results are illustrated in Figure ⁶ and the data are summarized and compared to Resin ^C in Table 7· The data show that resin ^D had an enhanced radiation crosslinking efficiency as compared to Resin ^C (data shown earlier in Example 2, Table 4). Resin D, having I10/I2 of about 12, had ^a crosslink density at a dosage of about ³ Mrad of approximately ¹⁸ to 20 percent gel, whereas resin ^C does not attain ^a cross-link density of about 20 percent gel until exposure to about ⁷ Mrad. Resin ^D would, therefore, attain higher shrinkage at

TABLE 6 Heat Seal Strength of Resin ^B after Irradiation Treatment

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lower levels of irradiation than resin C, and is thus an example of this invention for use as ^a core layer in ^a multilayer structure.

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Example 4

This example demonstrates a two layer coextruded film product having improved heat seal, crosslinking and orientation/shrink performance after ⁵ irradiation to ³ Mrad.

^A ¹ mil (0.025 mm) thick 2-layer (A/B) coextruded film sample was fabricated by the following blown film process:

Two layer blown films were prepared in accordance with this invention by fabrication on an Egan coextrusion blown film line equipped with ^a 2.5 inch (6.4 cm) diameter main extruder, a 1.5 inch (3.8 cm) ¹⁵ skin layer extruder and a ² layer single air ring cooled

annular die. The multilayer laminated film structure was an A/B configuration in which:

(I) The "A-layer" was the heat seal layer and 20 was extruded through the outer annular die as the outer layer. The "A~layer" extruder was a 1.5 inch (3.8 cm) Egan having an L/D ratio of 20:1. The extruder had four zones temperature control. This extruder was used to feed Resin C- to the outer layer. This layer was ²⁵ maintained at ^a thickness of approximately 0.15 mils (0.0038 mm). The temperature profile of this extruder was as follows:

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The polymer melt temperature was about 225°C. The throughput rate was about ¹⁸ pounds/hour (8.2 kg/hr).

(II) The "B-layer" is the support or core layer and was extruded through the inner annular die as ⁵ the inside layer. The "B-layer" extruder was a 2.5 inch (6.35 cm) Egan having ^a screw L/D ratio of 24:1. This extruder is used to feed Resin ^D to the middle annular die to form the inner layer at a throughput of about 110 pounds/hour (50 kg/hr) and at a melt temperature of ¹⁰ about 225°C. The thickness of this layer is approximately 0.85 mils (0.022 mm). The temperature profile of this extruder is as follows:

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Resin ^C described in Example 2 was used to fabricate the heat seal layer and Resin ^D described in Example ³ was used to fabricate the other layer. The thickness of the heat seal layer is approximately ¹⁵ percent of the total film thickness of about ¹ mil (0.025 mm). The film sample is irradiated at ³ Mrad using an Energy Science Incorporated electron beam radiation machine (Model EC200). The total crosslink 3^q **density of the film, measured as percent gel, after the radiation treatment was approximately ¹⁶ percent. At crosslink densities of between about ¹⁰ percent and about 25 percent, the film is known to have ideal**

performance for orientation and shrink applications.

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The heat seal performance (heat seal layer to heat seal layer) of this co-extruded crosslinked film was evaluated by the method described in Example 1. Table ⁸ illustrates the heat seal strength of the heat seal layer of film before and after radiation treatment (3 Mrad). The film retained its excellent heat seal performance after the electron beam radiation treatment. Table 8

Heat Seal Strength of the Heat Seal Layer of Coextruded Film Samples before and after Irradiation

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Claims:

1. ^A multilayer heat-sealable thermoplastic film structure having improved heat seal performance after electron beam irradiation, said film structure comprising at least one heat-sealable outer layer (A) and at least one core layer (B), wherein layer (A) comprises ^a first linear polyethylene characterized as ' having:

(a) a density from 0.88 g/cm³ to 0.92 g/cm3,

(b) a melt index, measured as 12» from ² g/10 minutes to 20 g/10 minutes,

(c) a molecular weight distribution, measured as Ι10/Ι2» from ⁵ tc 3, and wherein

(d) ¹⁵ percent by weight or less of said first linear polyethylene has a degree of branching less than or equal to 2 methyls/1000 carbons, and

¹⁵ (e) ²⁵ percent by weight or less of said first linear polyethylene has ^a degree of branching equal to or greater than 25 methyls/1000 carbons, and wherein layer (B) comprises a second linear polyethylene characterized as having:

(f)^a density from 0.88 g/cm³ to 0.94 g/om3,

(g) a melt index, measured as I2, from 0.05 g/10 minutes to ⁵ g/10 minutes, and

(h) a molecular weight distribution, measured as Ι10/Ι2» from ⁸ to 30. ²⁵

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This example illustrates that by using the resins disclosed in this invention for specific layers, a multi-layer film can be made, exposed to radiation and still maintain ^a combination of excellent core layer crosslinking performance and excellent heat seal layer performance.

10 15 of the heat seal layer is maintained after irradiation The invention is particularly useful in heatseal packaging of food, whereby the packaged food is exposed to irradiation for sterilization purposes. The irradiation simultaneously strengthens the core layer and prepares it for shrinkage upon subsequent exposure to heat. By using the present invention in the heat seal outer layer, the heat al initiation temperature and the heat seal strength of the package is substantially maintained.

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2. The film structure of claim ¹ wherein layer (A) is adjacent to layer (B).

3. The film structure defined by claim ¹ or 2 which has been electron beam irradiated from 0.5 Mrad to 20 Mrad to form an irradiated film structure.

4. The irradiated film structure according to any one of claims ¹ to 3 wherein the ⁵ heat-sealable outer layer (A) has a cross-link density of less than 10 percent gel after 5 Mrad radiation dosage or less.

5. The irradiated film structure according to any one of claims ¹ to 4 wherein the heat-sealable outer layer (A) has a cross-link density of less than 10 percent gel after 4 Mrad radiation dosage.

io 6. The irradiated film structure according to any one of claims ¹ to 5 wherein the layer (B) has a cross-link density of at least 30 percent gel after 5 Mrad radiation dosage or less.

7. The irradiated film structure according to any one of claims ¹ to 5 wherein the layer (B) has a cross-link density of at least 20 percent gel after 4 Mrad radiation dosage.

¹⁵ 8. The irradiated film structure according to any one of claims ¹ to 7 which has been subsequently heat sealed to form an irradiated and heat sealed film structure.

9. The irradiated and heat sealed film structure of claim 8 wherein said film structure has a heat seal strength of at least 3.9 N/cm at a heat seal temperature of at least 91°C after electron beam irradiation of 4 Mrad.

20 10. The irradiated and heat sealed film structure of claim 14 or 15 wherein the heat seal temperature is 93°C or less.

11. A multilayer heat-sealable thermoplastic film structure having improved heat seal performance after electron beam irradiation substantially as herein described with reference to any one of the examples.

²⁵ Dated 6 February, 1996 The Dow Chemical Company **Patent Attorneys for the Applicant/Nominated Person . SPRUSON & FERGUSON**

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FIG. 7

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